

High Power Switch with Integrated Bias Controller 30 MHz - 6.0 GHz

Rev. V4

Features

- Broadband Performance
- Low Loss:
 - TX = 0.3 dB @ 2.7 GHz
 - RX = 0.4 dB @ 2.7 GHz
- High Isolation:
 - RX = 43 dB @ 2.7 GHz
- Up to 125 W CW Power Handling @ +85°C
- Fast Switching Speed 350 ns
- Single +5 V DC Supply
- Compatible with 1.8 V and 3.3 V logic
- Lead-Free 5 mm 20-Lead HQFN Package
- Halogen-Free “Green” Mold Compound
- RoHS* Compliant
- Suitable for High Power TDD-LTE applications

Description

The MAMF-011070 is a high power broadband PIN diode SPDT switch with a 5 V power management chip designed for 30 MHz to 6 GHz high power applications.

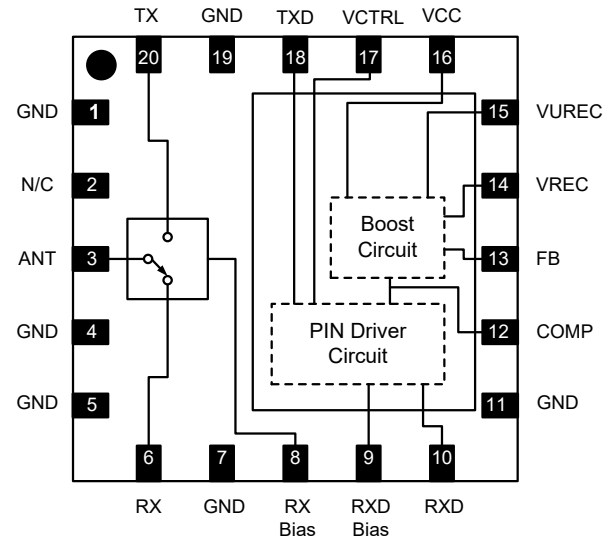
The device features low insertion loss, high isolation with low DC power consumption. It has an integrated bias controller utilizing a boost circuit. This switch requires only a single 5 V supply, and a single TX / RX control signal that is compatible with 1.8 V or 3.3 V logic.

Ordering Information^{1,2}

Part Number	Package
MAMF-011070-TR3000	3000 Piece Reel
MAMF-011070-TR1000	1000 Piece Reel
MAMF-011070-001SMB	Sample Board

1. Reference Application Note M513 for reel size information.
2. Sample board includes 4 loose parts.

Functional Schematic



Pin Configuration³

Pin #	Pin Name	Function
1, 4, 5, 7, 11, 19	GND	Ground
2	N/C	No Connection ⁴
3	ANT	RF Input
6	RX	RX Output/Series Bias
8	RX BIAS	RX Shunt Bias
9	RXD BIAS	RX Shunt Driver Output
10	RXD	RX Series Driver Output
12	COMP	DC-DC Comp
13	FB	DC-DC Feedback
14	VREC	DC-DC Boost Voltage
15	VUREC	DC-DC VUREC
16	VCC	5 V Supply
17	VCTRL	T/R Logic Control
18	TXD	TX Driver Output
20	TX	TX Output/Bias
21	Paddle	Ground ⁵

3. MACOM recommends connecting unused package pins to ground.
4. Pin 2 may be connected to the ANT trace on a PCB without affecting the performance.
5. The exposed pad centered on the package bottom must be connected to RF, DC and thermal ground.

¹ * Restrictions on Hazardous Substances, compliant to current RoHS EU directive.

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**Electrical Specifications: Freq. = 2.7 GHz, $T_A = +25^\circ\text{C}$, $V_{CC} = 4.5\text{ V}$, $Z_0 = 50\ \Omega$,
TX mode: ANT to TX ON, $V_{CTRL} = 1.2\text{ V}$, V_{CC} Current = 170 mA⁶;
RX mode: ANT to RX ON, $V_{CTRL} = 0.6\text{ V}$, V_{CC} Current = 100 mA⁶**

Parameter	Test Conditions	Units	Min.	Typ.	Max.
Insertion Loss	ANT to TX ON ANT to RX ON	dB	—	0.3 0.4	0.6 0.8
Isolation	ANT to RX (TX mode) ANT to TX (RX mode)	dB	37 —	43 15	—
ANT Input Return Loss	ANT to RX ON ANT to TX ON	dB	—	25 22	—
TX Output Return Loss	ANT to TX ON	dB	—	21	—
RX Output Return Loss	ANT to RX ON	dB	—	25	—
Input P-0.1 dB	ANT to TX ON @ VSWR = 1.2:1	dBm	—	50.5	—
IIP3 TX mode	ANT to TX, $P_{IN} = 30\text{ dBm}$	dBm	—	68	—
IIP3 RX mode	ANT to RX, $P_{IN} = 30\text{ dBm}$	dBm	—	68.5	—
RF Input Power C.W. ANT to TX ON	85°C @ 1.8, 2.7, 3.5 GHz; VSWR < 1.2:1 100°C @ 1.8, 2.7, 3.5 GHz; VSWR < 1.2:1 120°C @ 1.8, 2.7, 3.5 GHz; VSWR < 1.2:1	dBm / W	—	51.0 / 125 50.0 / 100 45.5 / 35	—
Switching Speed TX ON T_{RISE} T_{FALL}	DC ctrl Pulse Rate = 500 KHz, PW = 1 μsec 10% to 90% RF 90% to 10% RF	ns	—	230 190	—
Switching Speed TX ON T_{ON} T_{OFF}	DC ctrl Pulse Rate = 500 KHz, PW = 1 μsec 50% VCTRL to 90% RF 50% VCTRL to 10% RF	ns	—	350 310	—
Switching Speed RX ON T_{RISE} T_{FALL}	DC ctrl Pulse Rate = 500 KHz, PW = 1 μsec 10% to 90% RF 90% to 10% RF	ns	—	170 90	—
Switching Speed RX ON T_{ON} T_{OFF}	DC ctrl Pulse Rate = 500 KHz, PW = 1 μsec 50% VCTRL to 90% RF 50% VCTRL to 10% RF	ns	—	340 210	—
Group Delay	—	ns	—	50	—
In-band Ripple	20 MHz 200 MHz	dB	—	0.05 0.1	—

6. The average current is set with external resistors: R1, R2, R3, and R4 as shown in the sample board schematic. The resistor values can be adjusted higher to reduce the V_{CC} average current.

Maximum Operating Conditions

Parameter	Operating Maximum
RF Input Power C.W.	51 dBm @ +85°C, 3.5 GHz, VSWR = 1.2:1
V _{CC}	4.5 V to 5.5 V
Junction Temperature ⁷ Switch	+175°C
Junction Temperature ^{8,9} Integrated Bias Controller	+125°C
Case (Paddle) Temperature	-40°C to +120°C
Storage Temperature	-55°C to +150°C

7. Operating at nominal conditions with $T_J \leq +175^\circ\text{C}$ will ensure $\text{MTTF} > 1 \times 10^6$ hours.
8. Operating at nominal conditions with $T_J \leq +125^\circ\text{C}$ will ensure $\text{MTTF} > 1 \times 10^5$ hours.
9. Absolute maximum junction temperature of 150°C; exceeding this temperature may cause permanent damage to the device. MACOM does not recommend sustained operation near this temperature.

Truth Table

ANT – TX	ANT – RX	VCTRL
ON	OFF	HIGH (1.2 - 3.6 V)
OFF	ON	LOW (0 - 0.6 V)

Handling Procedures

Please observe the following precautions to avoid damage:

Static Sensitivity

These electronic devices are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

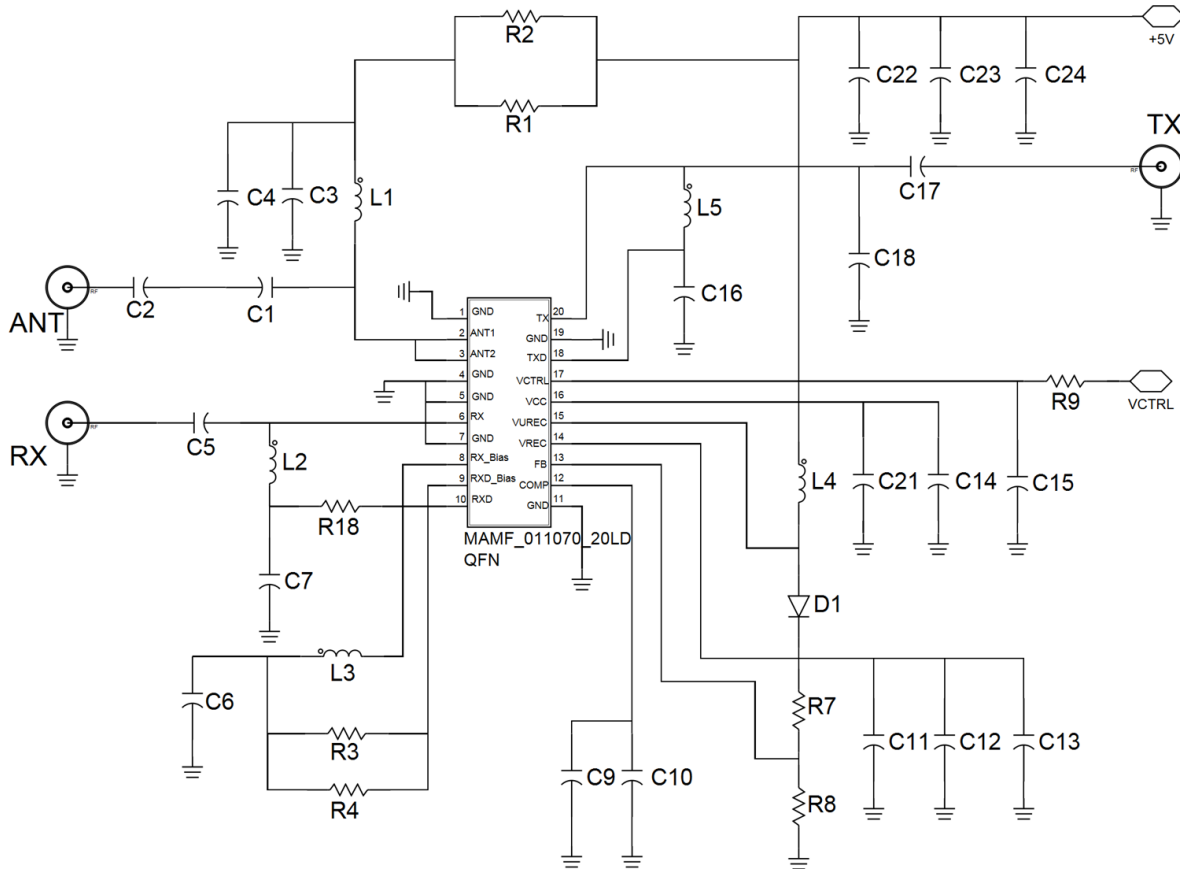
Parameter	Rating	Standard
Human Body Model (HBM)	500 V (Class 1B)	ESDA / JEDEC JS-001
Charged Device Model (CDM)	1000 V (Class C3)	JEDEC JESD22-C101
IC Latch-up Test	Class II	JEDEC JESD78

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Application Schematic

NOTE: Contact factory for sample board layout including considerations for thermal dissipation through the PCB.



Switch Biasing Information

R1 and R2 are used to set the forward bias current (I_F) of the TX or the RX series diode. The I_F controls the Insertion Loss of the ANT to TX or ANT to RX path respectively.

For $R1 = R2 = 69.8 \Omega$ the $I_F = 0.1 \text{ A}$

$R1 = R2 = 2 * (VCC - 1.52 \text{ V}) / I_F$.

R1 & R2 must meet the following power requirement:

$$P_{R1/2} > (0.5 * I_F)^2 * R1$$

R3 and R4 are used to set the forward bias current (I_{FShD}) in the RX shunt diode of the switch. The I_{FShD} controls the RX isolation.

For $R3 = R4 = 3.6 \text{ k}\Omega$ the $I_{FShD} = 0.01 \text{ A}$

$R3 = R4 = 2 * (18 \text{ V}) / I_F$

These resistors must meet the following power requirement:

$$P_{R3/4} > (0.5 * I_{FShD})^2 * R3$$

Boost Biasing Information

D1 diode requirements: $V_B = 40 \text{ V}$, Forward Current = 200 mA, Forward Surge Current = 750 mA

During boost period, VUREC (Pin 15) transient peak voltage and current can be as high as 24 V and 750 mA. Use recommend components from Parts List for proper current handling.

R7 and R8 are a resistive divider used to set the boost voltage. Use recommended components from Parts List for proper boost performance.

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Parts List¹⁰

Component ID	Value	Package	Part Number	Manufacturer	Spec
MAMF-011070	—	HQFN-20LD 5 mm	MAMF-011070	MACOM	—
L1, L2	33 nH	1 x 0.5 mm	LQW15AN33NJ8ZD	Murata	620mA/125°C
L3, L5	10 nH	1.6 x 0.8 mm	LQW18AN10NG00D	Murata	650mA/10nH
L4	10 µH	2.5 x 2 mm	IFSC1008ABER100M01	Vishay	750mA/0.41Ω
C1, C2, C17	10 pF	0505	800A100JT250X	ATC	250V/125°C
C3, C7, C16	1 nF	0603	—	—	50V/125°C
C4	1 µF	0805	CL21B105KBFNNNG	Samsung Electro-Mechanics	50V/125°C
C5	5.6 pF	0603	600S5R6AT250XT	ATC	250V/125°C
C6	100 pF	0603	—	—	250V/125°C
C9, C13	2.2 µF	1210	—	—	35V/125°C
C10	470 pF	0402	—	—	50V/125°C
C11	100 nF	0805	—	—	50V/125°C
C12	10 nF	0805	—	—	50V/125°C
C14, C24	10 µF	0603	—	—	10V/125°C
C15	10 pF	0402	—	—	50V/125°C
C18	0.3 pF	0603	600S0R3AT250XT	ATC	250V/±0.05pF/125°C
C21, C22, C23	10 nF	0603	—	—	50V/125°C
R1, R2	69.8 Ω	1206	—	—	0.25W/0.1%/155°C
R3, R4	3.6 KΩ	0603	—	—	0.2W/0.1%/155°C
R18	0 Ω	0402	—	—	125°C
R7	1.6 MΩ	0402	—	—	0.063W/1%/155°C
R8	115 KΩ	0402	—	—	0.063W/1%/155°C
R9	100 Ω	0402	—	—	125°C
D1	—	SOT23-3	CMPSH-3CE TR	Central Semiconductor	750mA/40V/155°C
ANT, RX, TX	RF CONN	SMA	142-0761-821	Cinch Connectivity Solutions	—
DC CONN	DC CONN	10PIN	—	—	10 pin header

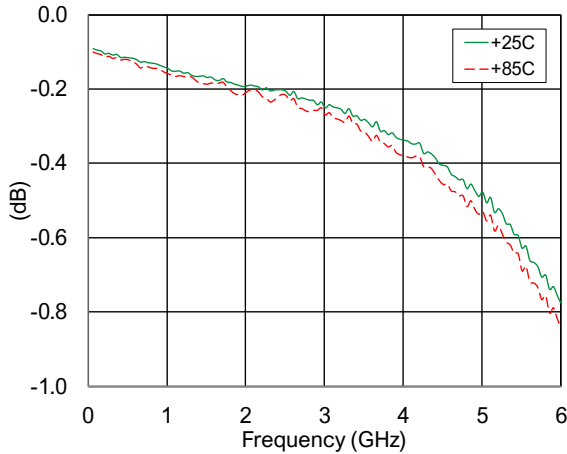
10. MACOM datasheet performance was captured using components from manufacturers shown. These parts are critical to meet specified performance. All other parts must meet ratings specified but do not have specific manufacturer recommendations.

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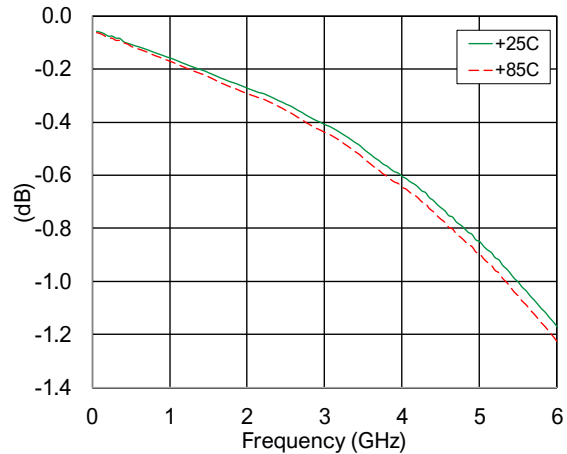
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Typical Performance Curves - Probed on the Sample Board (no PCB Bias Components)

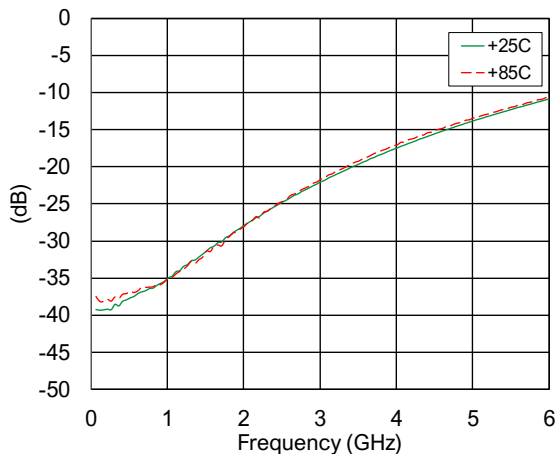
ANT to TX Insertion Loss



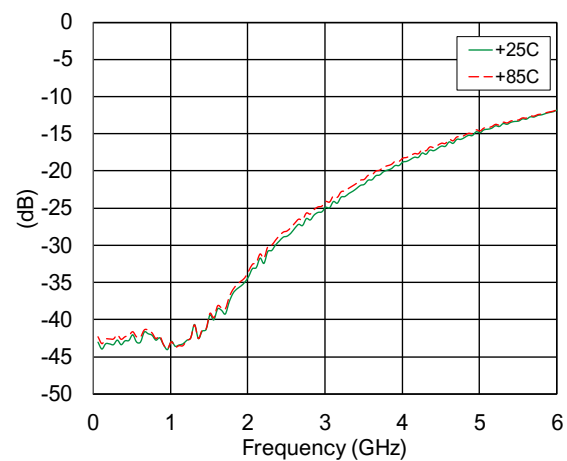
ANT to RX Insertion Loss



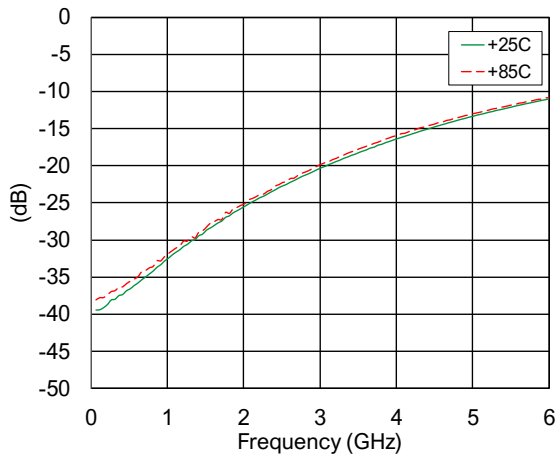
ANT Return Loss in TX ON state



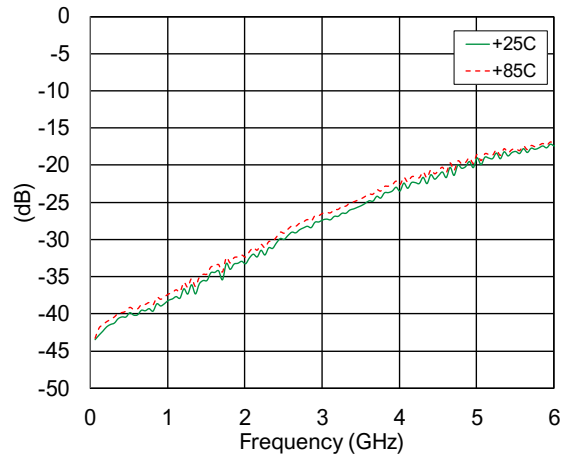
ANT Return Loss in RX ON state



TX Return Loss in TX ON state

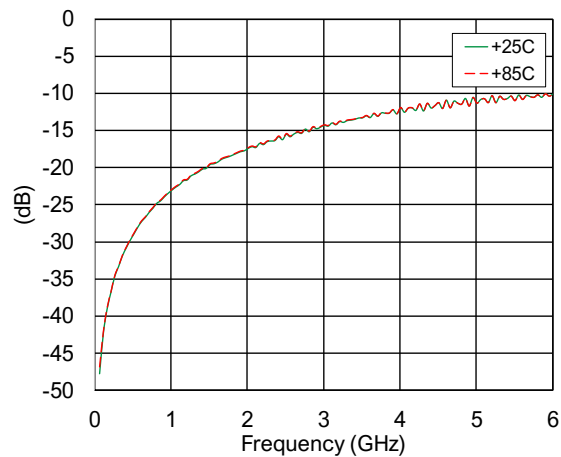


RX Return Loss in RX ON state

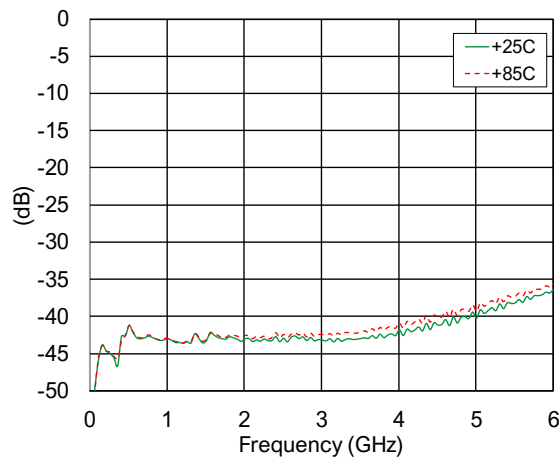


Typical Performance Curves - Probed on the Sample Board (no PCB Bias Components)

ANT to TX Isolation



ANT to RX Insertion

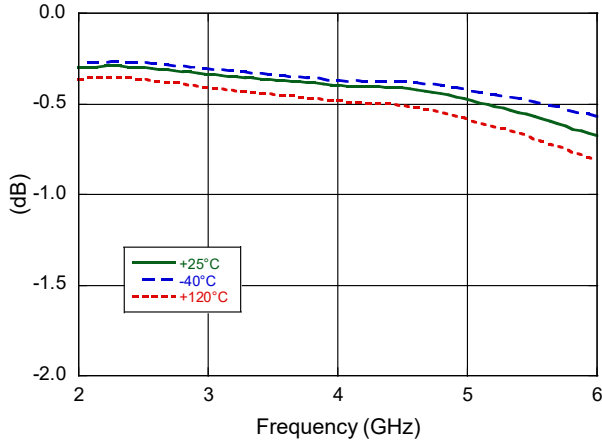


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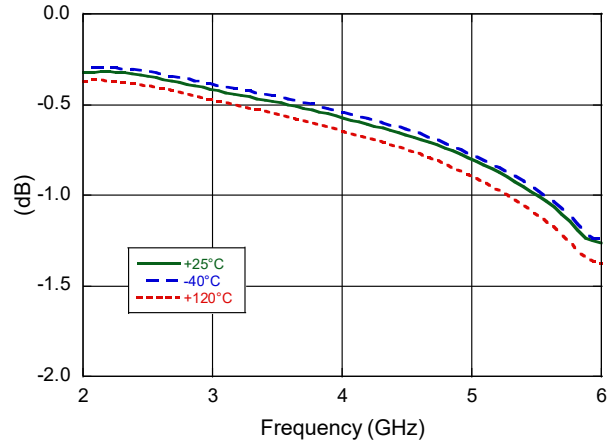
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Typical Performance Curves on the Sample Board optimized for 2 - 6 GHz performance

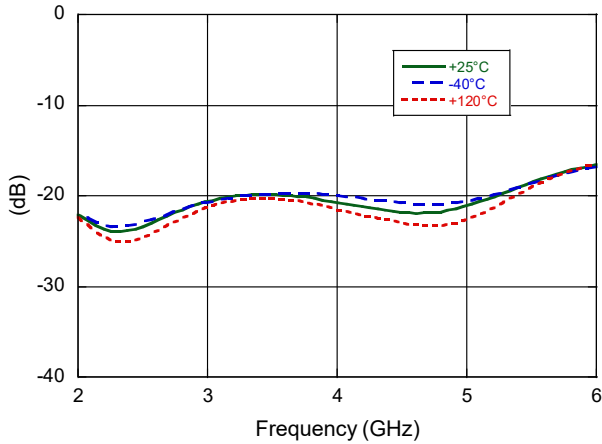
ANT to TX Insertion Loss (PCB loss de-embedded)



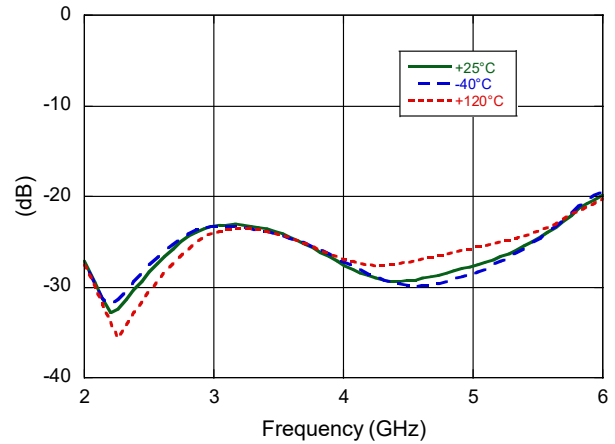
ANT to RX Insertion (PCB loss de-embedded)



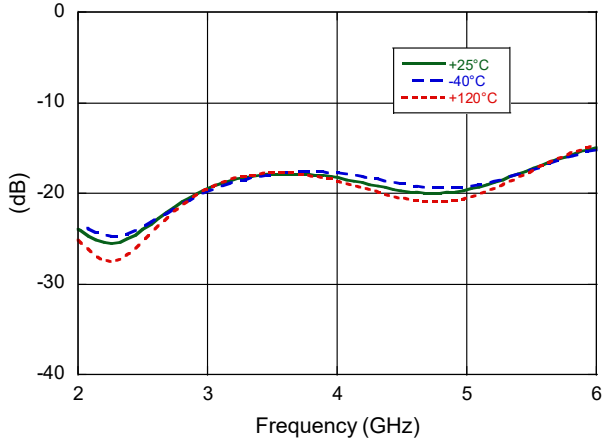
ANT Return Loss in TX ON state



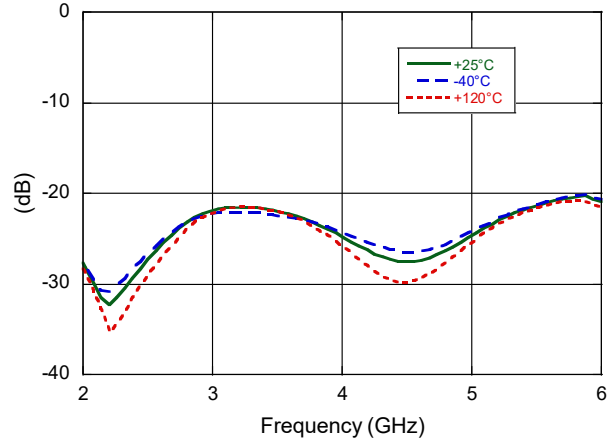
ANT Return Loss in RX ON state



TX Return Loss in TX ON state



RX Return Loss in RX ON state

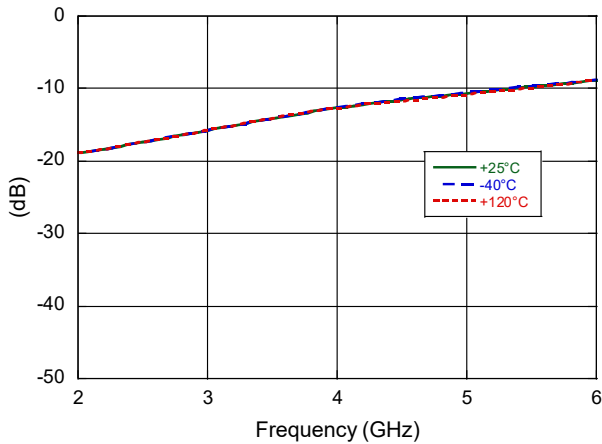


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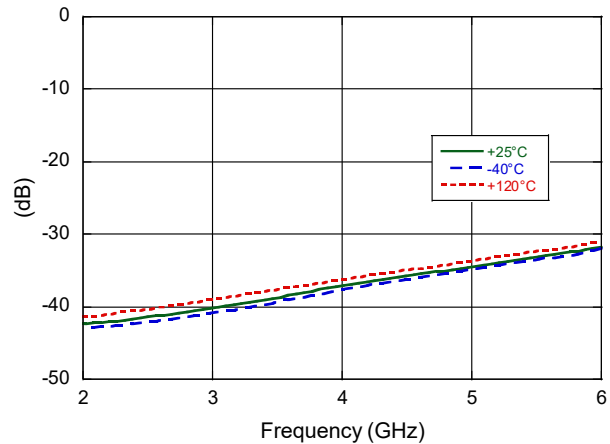
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Typical Performance Curves on the Sample Board optimized for 2 - 6 GHz performance

ANT to TX Isolation

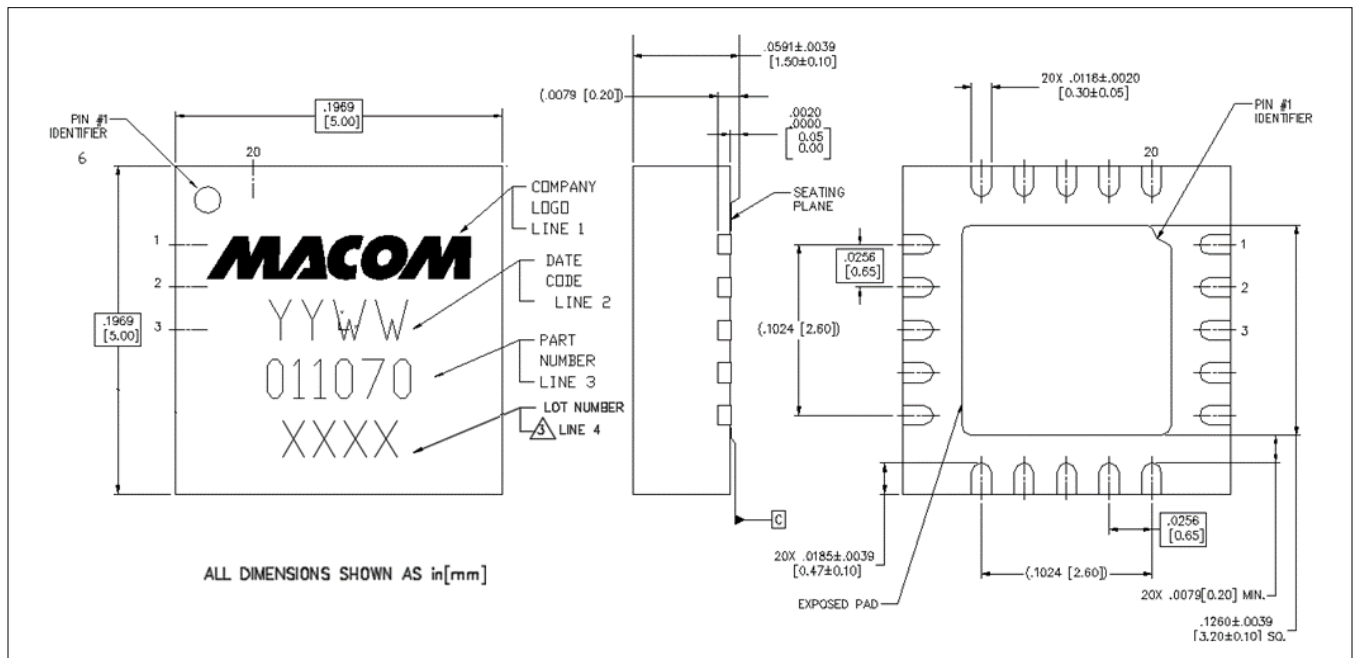


ANT to RX Isolation¹⁰



10. ANT to RX isolation has strong dependence on board layout.

Lead-Free 5 mm 20-Lead HQFN[†]



[†] Reference Application Note M538 for lead-free solder reflow recommendations.
 Meets JEDEC moisture sensitivity level 3 requirements.
 Plating is NiPdAuAg

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